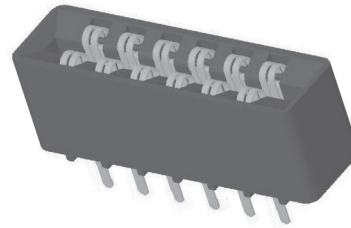




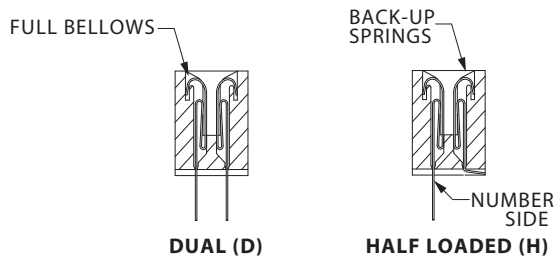
.156" [3.96 mm] Contact Centers, .431" [10.95 mm] Insulator Height, Dip Solder/Eyelet/Right Angle

SPECIFICATIONS

- Accommodates .062" $\pm$.008" [1.57 mm $\pm$ 0.20 mm] PC board
- Molded-in key available
- 3 Amps current rating for one contact energized
(for 5 Amps application, consult factory)
- 30 milli Ohms maximum at rated current
- UL Flammability Rating: 94V-0

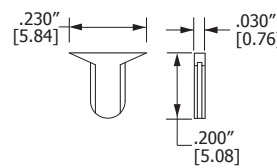


READOUT

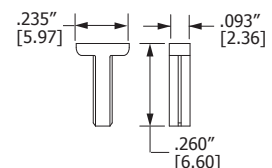


POLARIZING KEY

PLA-K1 KEY IN BETWEEN CONTACTS (ORDER SEPARATELY)



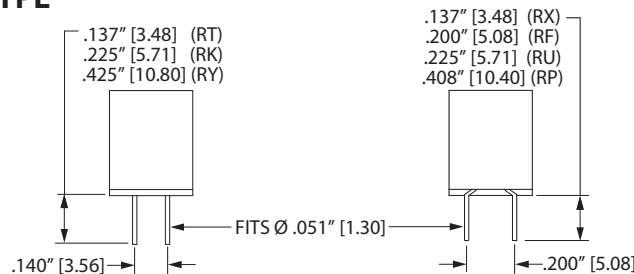
PLM-K2 KEY IN CONTACT (ORDER SEPARATELY)



CONSULT FACTORY FOR MOLDED-IN KEY

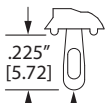
TERMINATION TYPE

EYELET ACCEPTS 3-#22 AWG



(RA) .125" [3.18] FOR ALL POSITIONS
(SA) .270" [6.85] 02 THRU 25 POSITIONS
(SA) .230" [5.84] 28 THRU 36 POSITIONS
(SA) .190" [4.82] 43 POSITIONS
TOLERANCE: (RA) $\pm$.025" [0.64]
(SA) $\pm$.040" [1.00]

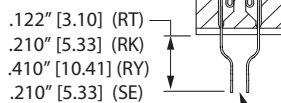
ALTERNATE EYELET SHAPE * (RE) .014" [0.36] THICK



(SE) .007" [0.18] THICK
(RE) .014" [0.36] THICK

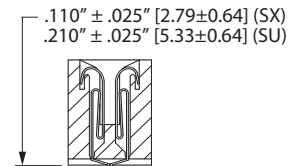
EYELET (SE OR RE)

NARROW DIP SOLDER (RT, RK, RY)

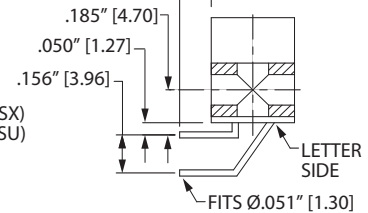


ACCEPTS .062" [1.57] PCB

WIDE DIP SOLDER (RF, RX, RU, RP)



FITS $\varnothing$.051" [1.30]
MINIMUM

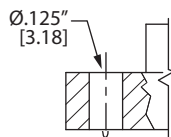


RIGHT ANGLE, DIP SOLDER (RA, SA)

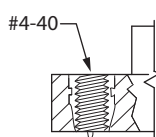
CARD EXTENDER (RT, RK, RY, SE TERMINATIONS ONLY) REQUIRES -S13 MODIFICATION CODE

CENTERED DIP SOLDER (SX, SU) AVAILABLE WITH DUAL OR HALF LOADED READOUT TYPE

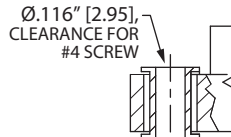
MOUNTING STYLE



CLEARANCE HOLE (H)



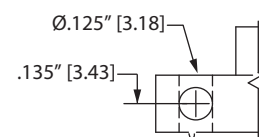
THREADED INSERT (I)



FLOATING BOBBIN (F)



NO MOUNTING EARS (N)



SIDE MOUNTING (S)

* Beryllium Copper & Beryllium Nickel (H, A, J, F, C & W Material Codes) Only.



PART NUMBER OPTIONS

MATERIALS (INSULATOR/CONTACT)

E = PBT/Phosphor Bronze (Standard)
 R = PPS/Phosphor Bronze
 G = PA9T/Phosphor Bronze
 H = PBT/Beryllium Copper
 A = PPS/Beryllium Copper
 J = PA9T/Beryllium Copper
 *F = PPS/Spinodal (Overall Gold Plating Only)
 Consult Factory for Special Soldering Guidelines
 *C = PPS/Beryllium Nickel (Overall Gold Plating Only)
 *W = PEEK/Beryllium Nickel (Overall Gold Plating Only)
 *Consult factory for availability.
 Refer to Page 7 for Operating/Processing Temperatures

CONTACT FINISH - RoHS Compliant

All platings are Lead Free and have .000050" Nickel underplate

Contact Surface	Termination
B = .000010" Gold	.000100" Pure Tin, Matte
C = .000030" Gold	.000100" Pure Tin, Matte
G = .000010" Gold	.000005" Gold
Y = .000030" Gold	.000005" Gold
Contact Surface	Overall Plating
S = .000010" Gold	.000010" Gold
M = .000030" Gold	.000010" Gold
E = .000100" Pure Tin, Matte	.000100" Pure Tin, Matte

CONTACT CENTERS

M = .156" [3.96 mm]

NUMBER OF CONTACT POSITIONS

See Chart Below

E B M 43 D RK H - Sxxx

MODIFICATION CODE (Consult Factory)
 OMIT FOR STANDARD

-S13 = Card Extender Accepts .062" [1.57 mm] PCB
 (RT, RK, RY, SE Terminations Only)

MOUNTING STYLE (Opposite Page)

H = .125" [3.18 mm] Clearance Holes
 N = No Mounting
 S = Side Mounting
 I = Threaded Insert
 F = Floating Bobbin

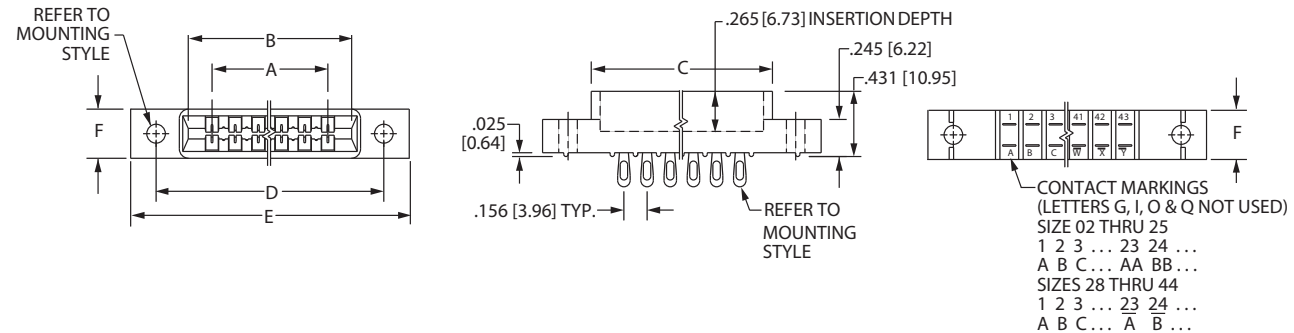
TERMINATION TYPE (Opposite Page)

RA = .125" [3.18 mm] Right Angle Dip Solder
 SA = Long Right Angle Dip Solder
 RT = .140" X .137" [3.56 mm X 3.48 mm] Dip Solder
 RK = .140" X .225" [3.56 mm X 5.72 mm] Dip Solder
 RY = .140" X .425" [3.56 mm X 10.80 mm] Dip Solder
 RX = .200" X .137" [5.08 mm X 3.48 mm] Dip Solder
 RF = .200" X .200" [5.08 mm X 5.08 mm] Dip Solder
 RU = .200" X .225" [5.08 mm X 5.72 mm] Dip Solder
 RP = .200" X .408" [5.08 mm X 10.36 mm] Dip Solder
 SX = .110" [2.79 mm] Centered Dip Solder
 SU = .210" [5.33 mm] Centered Dip Solder
 SE = .007" [0.18 mm] Thick Eyelet
 RE = .014" [0.36 mm] Thick Eyelet

READOUT (Opposite Page)

D = Dual
 D = Dual Row/ Crimp to Center for
 Single Readout (SX, SU Termination Only)
 H = Half Loaded

DIMENSIONS Dimensions in [] are in millimeters, all others are in inches.



Tolerances on non-critical dimensions may vary slightly due to shrinkage differential per insulator material; Consult factory.

POSITIONS/ CONTACTS	INCHES						MILLIMETERS					
	A±.008	B±.008	C±.015	D±.010	E MAX	F+.005/-0.015	A±0.20	B±0.20	C±0.38	D±0.25	E MAX	F+0.13/-0.38
02/04	0.156	0.476	0.596	'N' MOUNTING	1.902	0.325	3.96	12.09	15.14	'N' MOUNTING	48.31	8.26
03/06	0.312	0.632	0.752				7.92	16.05	19.10			
04/08*	0.468	0.788	0.908				11.89	20.02	23.06			
06/12	0.780	1.100	1.220				19.81	27.94	30.99	38.94		
07/14	0.936	1.256	1.376	1.689	2.058	0.438	23.77	31.90	34.95	42.90	52.27	11.13
08/16	1.092	1.412	1.532	1.845	2.214		27.74	35.86	38.91	46.86	56.24	
10/20	1.404	1.724	1.844	2.157	2.526		35.66	43.79	46.84	54.79	64.16	
11/22	1.560	1.880	2.000	2.313	2.682		39.62	47.75	50.80	58.75	68.12	
12/24	1.716	2.036	2.156	2.469	2.838		43.59	51.71	54.76	62.71	72.09	
15/30	2.184	2.504	2.624	2.937	3.306		55.47	63.60	66.65	74.60	83.97	
18/36	2.652	2.972	3.092	3.405	3.774		67.36	75.49	78.54	86.49	95.86	
22/44	3.276	3.596	3.716	4.029	4.398		83.21	91.34	94.39	102.34	111.71	
24/48	3.588	3.908	4.028	4.341	4.710		91.14	99.26	102.31	110.26	119.63	
25/50	3.744	4.064	4.184	4.497	4.866		95.10	103.23	106.27	114.22	123.60	
28/56	4.212	4.532	4.652	4.965	5.334	0.500	106.98	115.11	118.16	126.11	135.48	12.70
36/72	5.460	5.780	5.900	6.213	6.582		138.68	146.81	149.86	157.81	167.18	
43/86	6.552	6.872	6.992	7.305	7.674		166.42	174.55	177.60	185.55	194.92	
44/88	6.708	7.028	7.148	7.461	7.830		170.38	178.51	181.56	189.51	198.88	

* Consult factory for availability.